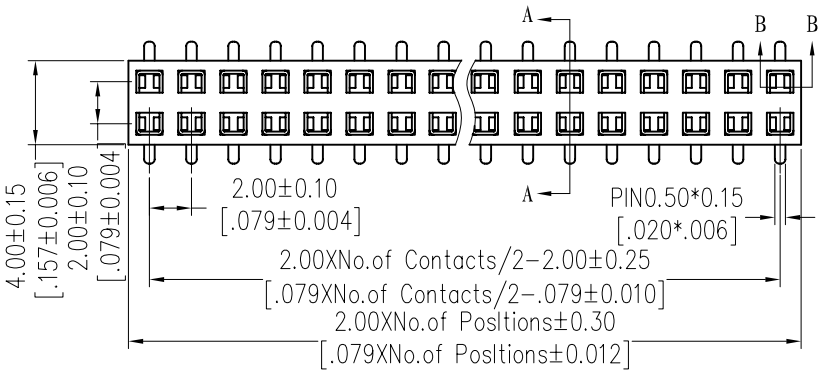
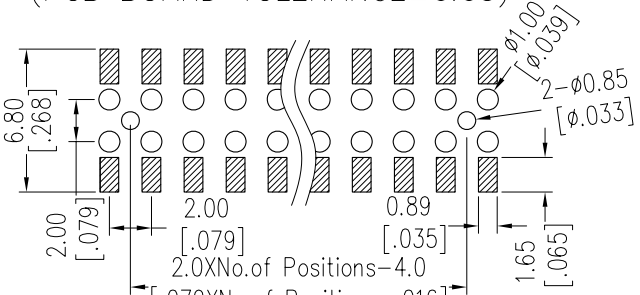
HSF

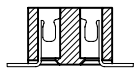
NOTES:
Current Rating: 2.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: -40℃ to +105℃

Contact Material: Phosphor Bronze
Contact plating: Au Or Sn over Ni
Insulator Material: PA9T+30%GF UL94V-0



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



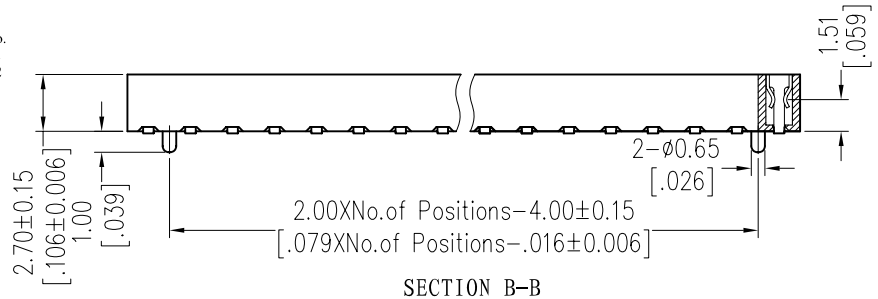


TYPE 1 W/O POST

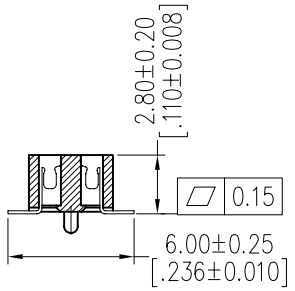
Ordering Information

2227T-2 XX M XX CUN T X

- XX: No.of Pins per Row: 02~40Pin
- XX: Contact Plating: G0=Gold Flash, G3=10μ"Gold, G4=15μ"Gold, G5=30μ"Gold, SN=Tin
- T: Packing: T=Tube, P=Tube+CAP, R=Tape&Reel+CAP
- X: Series No. 1=Type 1, 2=Type 2



SECTION B-B



TYPE 2 WITH POST

SECTION A-A

Item	Pitch	Mating
Standard	2.00	1215/1220
Alternate		

TITLE	PART NO.
TYPE 1	2227T-2XXMXXCUNT1
TYPE 2	2227T-2XXMXXCUNT2

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012/07/12	NEW	------

OPERATION		DRAW	DATE
X.X	±0.40	JYHuang	2012/07/12
X.XX	±0.25	CHECK	DATE
X.XXX	±0.15		
Angle	± 3°	APPROVE	DATE
DIM	TOL		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

PART NO.
SEE TABLE

TITLE:
FH2.00mm DUAL ROW 180° SMT
H=2.7

Customer NO.